

ENGINEERING CHANGE ORDER

POSCON - TOP LEVEL

Release ID	Change	Who	Assembly	Reason	Date
POSCON.v1.0	None	Rafael Send	n/a	First production version of new POSCON	10/13/2014
POSCON.v1.1	Fixed backplate stud size	Marc Levinson	.MECH	Inconsistent labeling between drawing and BOM	10/15/2014
	Moved PCB production files out, back into respective repos	Rafael Send	.PCB	Top level should not contain production files	10/15/2014
	Updated top level BOM to reflect new component tags	Rafael Send	TOP	Consistent naming	10/15/2014
POSCON.v1.2	Changes to POSCON.FACE & POSCON.BACK, added new part POSCON.CORE. New mounting schema. (Snaps)	Ethan Dale	.MECH	New POSCON.CORE part, redesign POSCON.BACK & POSCON.FACE, delete superseded parts	5/8/2015
	POSCON.PCB.v1.3 with LED and silkscreen fix. [v1.2 from Jan 13th never released at the top level: 5V MCU, 7Seg resistor, power trace and tented via upgrades]	Rafael Send	.PCB	Putwall LED (v1.3) & higher voltage (v1.2) compatible	8/11/2015
POSCON.v1.3	Added 0.031" radius to notches on back of POSCON.	Ethan Dale	.MECH	First articles came back from vendor with radiused notches, drawing change made to	09/09/15
	Corrected date on drawing to 09/09/2015	Ethan Dale	.MECH	Good data hygiene	09/10/15
	Included packing and assembly docs in BOM	Calla Belkin	TOP	Incomplete documentation	10/07/15